

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Riley D. Beck</td> <td>03/14/2013</td> </tr> <tr> <td>Kent Layton</td> <td>03/14/2013</td> </tr> <tr> <td>Scott R. Grange</td> <td>03/14/2013</td> </tr> </tbody> </table>		Name	Execution Date	Riley D. Beck	03/14/2013	Kent Layton	03/14/2013	Scott R. Grange	03/14/2013				
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RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>Semiconductor Components Industries, LLC</td> </tr> <tr> <td>Street Address:</td> <td>5005 E. McDowell Rd.</td> </tr> <tr> <td>Internal Address:</td> <td>A700</td> </tr> <tr> <td>City:</td> <td>Phoenix</td> </tr> <tr> <td>State/Country:</td> <td>ARIZONA</td> </tr> <tr> <td>Postal Code:</td> <td>85008</td> </tr> </table>		Name:	Semiconductor Components Industries, LLC	Street Address:	5005 E. McDowell Rd.	Internal Address:	A700	City:	Phoenix	State/Country:	ARIZONA	Postal Code:	85008
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
<p>Fax Number: 6022443169 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 602-244-6648 Email: PATENTS@ONSEMI.COM Correspondent Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC Address Line 1: 5005 E. MCDOWELL ROAD, Maildrop A700 Address Line 4: PHOENIX, ARIZONA 85008</p>													
ATTORNEY DOCKET NUMBER:	ONS01581												
NAME OF SUBMITTER:	Becky Newnam												
<p>Total Attachments: 2 source=ONS01581_Assignment#page1.tif source=ONS01581_Assignment#page2.tif</p>													

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ASSIGNMENT & AGREEMENT

ONS01581

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

<u>Name</u>	<u>of (City/State/Country)</u>
Riley D. Beck	EAGLE MOUNTAIN, UTAH UNITED STATES
Kent Layton	LEHI, UTAH, UNITED STATES
Scott R. Grange	PLEASANT GROVE, UTAH UNITED STATES

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

GROUND FAULT CIRCUIT INTERRUPTER AND METHOD

Attorney Docket No. ONS01581

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Riley D. Beck

Riley D. Beck

Kent Layton

Kent Layton

Scott R. Grange

Scott R. Grange

STATE OF UTAH)

COUNTY OF Utah)

I, Verena S. Critser, a Notary Public in and for the County and State aforesaid, do hereby certify that **Riley D. Beck, Kent Layton and Scott R. Grange**, whose name(s) are subscribed to the foregoing instrument, appeared before me this day in person and acknowledged that they/he/she signed, sealed and delivered the instrument as their/his/her free and voluntary act and deed for the uses and purposes therein set forth.

Given under my hand and notarial seal this 14 day of March, 2013.

Verena S. Critser
Notary Signature

My commission expires on: Sept 24, 2016

